



BZX84C7V5TS - BZX84C36TS

TRIPLE SURFACE MOUNT ZENER DIODE ARRAY

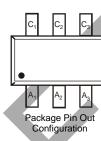
Features

- Zener Voltages from 7.5V 36V
- Three Isolated Diode Elements in a Single Ultra-Small Surface
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)

Mechanical Data

- Case: SOT-363
- Case Material: Molded Plastic.
 - UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020D
- Terminals: Solderable per MIL-STD-202, Method 208 (3)
- Lead Free Plating (Matte Tin Finish Annealed over Alloy 42 Leadframe).
- Weight: 0.006 grams (Approximate)





Ordering Information (Note 4)

Part Number	Case	Packaging		
(Type Number)-7-F*	SOT-363	3000/Tape & Reel		

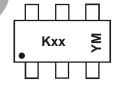
*Add "-7-F" to the appropriate type number in Electrical Characteristics Table on Page 2 example: 7.5V Zener = BZX84C7V5TS-7-F.

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.

 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + CI) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at http://www.diodes.com/products/packages.html

Marking Information (Note 5)



Kxx = Product Type Marking Code (See Electrical Characteristics Table) YM = Date Code Marking Y = Year (ex: A = 2013)M = Month (ex: 9 = September)

Date Code Key

Year	2006	2007	2008	2009	2010	2111	201	2 2	013	2014	2015	2016	2017	2018
Code	Т	U	V	W	Х	Υ	Z		Α	В	С	D	Е	F
Month	Jan	Feb	Ma	r A	or N	lay	Jun	Jul		Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	ļ	5	6	7		8	9	0	N	D

Note: 5. Product manufactured with Date Code UO (week 40, 2007) and newer are built with Green Molding Compound. Product manufactured prior to Date Code UO are built with Non-Green Molding Compound and may contain Halogens or Sb2O3 Fire Retardants.



Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	
Forward Voltage	@ I _F = 10mA	V _F	0.9	V

Thermal Characteristics

Characteristic		Symbol	Value	Unit
Power Dissipation	(Note 6)	P_{D}	200	mW
Thermal Resistance, Junction to Ambient Air	(Note 6)	$R_{\Theta JA}$	625	°C/W
Operating and Storage Temperature Range		$T_{J_i} T_{STG}$	-65 to +150	°C

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

			Zener Vo Range (N	-		Maximum Zener Impedance (Note 8)			Maximum Reverse Current (Note 7)		Temperature Coefficient of	
Type Number	Marking Code		Vz @ I _{ZT}		I _{ZT}	Z _{ZT} @ I _{ZT}	Z _{ZK} @ I _{ZK}	I _{ZK}	I _R	V _R		/oltage = 5mA /ºC
		Nom (V)	Min (V)	Max (V)	mA	2	7	mA	μA	@V	Min	Max
BZX84C7V5TS	KR6	7.5	7.0	7.9	5	15	80	1.0	1.0	5.0	2.5	5.3
BZX84C9V1TS	KR8	9.1	8.5	9.6	5	15	100	1.0	0.5	6.0	3.8	7.0
BZX84C22TS	KP8	22.0	20.8	23.3	5	55	250	1.0	0.1	15.4	16.4	l
BZX84C30TS	KPB	30.0	28.0	32.0	2	80	300	0.5	0.1	21.0	24.4	
BZX84C33TS	KPC	33.0	31.0	35.0	2	80	325	0.5	0.1	23.1	27.4	
BZX84C36TS	KPD	36.0	34.0	38.0	2	90	350	0.5	0.1	25.2	30.4	

es: 6. Mounted on FR4 PC Board with recommended pad layout which can be found on our website at http://www.diodes.com/datasheets/ap02001.pdf.

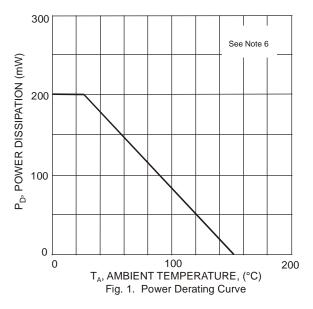
7. Short duration pulse test used to minimize self-heating effect.

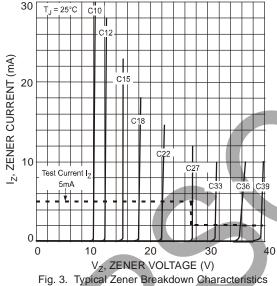
8. f = 1KHz.

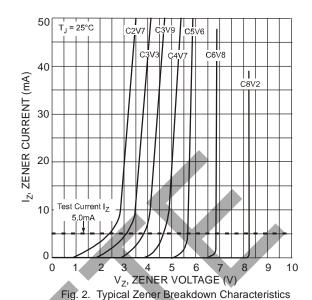
9. Qualified to AEC-Q101 standards for high reliability











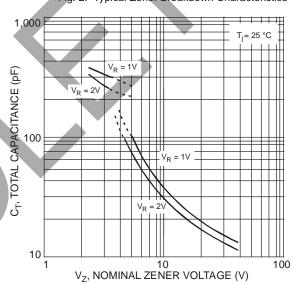
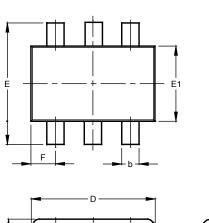


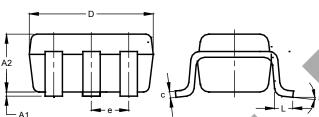
Fig. 4. Typical Total Capacitance vs. Nominal Zener Voltage



Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.





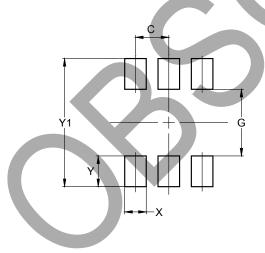
		_					
SOT363							
Dim	Min	Max	Тур				
A1	0.00	0.10	0.05				
A2	0.90	1.00	0.95				
b	0.10	0.30	0.25				
С	0.10	0.22	0.11				
D	1.80	2.20	2.15				
Е	2.00	2.20	2.10				
E1	1.15	1.35	1.30				
e	C	.650 E	SC				
F	0.40	0.45	0.425				
L	0.25	0.40	0.30				
а	0°	8°					
All I	Dimen	sions	in mm				

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.



SOT363



Dimensions	Value (in mm)
С	0.650
G	1.300
Х	0.420
Υ	0.600
Y1	2 500



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